



PATENT APPLICATION

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re the Application of

Hiroyuki KUMAKURA

Group Art Unit: 1711

Application No.: 09/761,191

Examiner: S. McClendon

Filed: January 18, 2001

Docket No.: 108379

For: ADHESIVE COMPOSITION

+5/B
5/14/02

AMENDMENT

Director of the U.S. Patent and Trademark Office
Washington, D.C. 20231

Sir:

In reply to the Office Action mailed February 13, 2002, please amend the
above-identified application as follows:

IN THE CLAIMS:

Please replace claims 1, 3 and 5 as follows:

Sub C1

~~1.~~ (Amended) An adhesive composition, comprising:
~~an insulating resin;~~
~~a photopolymerization initiator; and~~
~~an oxetan compound having two oxetane functional groups.~~

X8

B2
3. (Twice Amended) The adhesive composition according to claim 1, further
comprising electrically conductive particles.

B3

5. (Amended) The adhesive composition according to claim 2, further comprising
electrically conductive particles.

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